

General Description

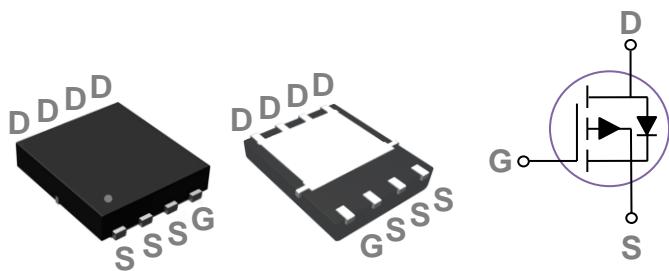
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BVDSS | RDSON | ID |
|-------|-------|-------|
| -40V | 4.1mΩ | -145A |

Features

- -40V, -145A, RDS(ON) = 4.1mΩ@VGS = -10V
- Fast switching
- Green Device Available
- Suit for -4.5V Gate Drive Applications

PPAK5X6 Pin Configuration



Applications

- Notebook
- Load Switch
- Networking

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | -40 | V |
| V _{Gs} | Gate-Source Voltage | ±20 | V |
| I _D | Drain Current – Continuous ($T_c=25^\circ\text{C}$) | -145 | A |
| | Drain Current – Continuous ($T_c=100^\circ\text{C}$) | -92 | A |
| I _{DM} | Drain Current – Pulsed ¹ | -580 | A |
| EAS | Single Pulse Avalanche Energy ² | 644 | mJ |
| IAS | Single Pulse Avalanche Current ² | -113.5 | A |
| P _D | Power Dissipation ($T_c=25^\circ\text{C}$) | 179 | W |
| | Power Dissipation – Derate above 25°C | 1.43 | W/°C |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R _{θJA} | Thermal Resistance Junction to Ambient | --- | 62 | °C/W |
| R _{θJC} | Thermal Resistance Junction to Case | --- | 0.7 | °C/W |

Electrical Characteristics ($T_J=25\text{ }^{\circ}\text{C}$, unless otherwise noted)
Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------|--------------------------------|---|------|------|-----------|---------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=-250\mu\text{A}$ | -40 | --- | --- | V |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=-40\text{V}$, $V_{GS}=0\text{V}$, $T_J=25\text{ }^{\circ}\text{C}$ | --- | --- | -1 | μA |
| | | $V_{DS}=-32\text{V}$, $V_{GS}=0\text{V}$, $T_J=125\text{ }^{\circ}\text{C}$ | --- | --- | -10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$ | --- | --- | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|-----------------------------------|---|------|------|------|------------------|
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance | $V_{GS}=-10\text{V}$, $I_D=-30\text{A}$ | --- | 3.4 | 4.1 | $\text{m}\Omega$ |
| | | $V_{GS}=-4.5\text{V}$, $I_D=-20\text{A}$ | --- | 4.4 | 5.7 | $\text{m}\Omega$ |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=-250\mu\text{A}$ | -1.2 | -1.6 | -2.5 | V |

Dynamic and switching Characteristics³

| | | | | | | |
|--------------|------------------------------|--|-----|------|-------|----|
| Q_g | Total Gate Charge | $V_{DS}=-20\text{V}$, $V_{GS}=-10\text{V}$, $I_D=-70\text{A}$ | --- | 155 | 235 | nC |
| Q_{gs} | Gate-Source Charge | | --- | 29 | 45 | |
| Q_{gd} | Gate-Drain Charge | | --- | 10.4 | 16 | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=-20\text{V}$, $V_{GS}=-10\text{V}$, $R_G=6\Omega$ $I_D=-70\text{A}$ | --- | 25 | 40 | ns |
| T_r | Rise Time | | --- | 35 | 55 | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 100 | 150 | |
| T_f | Fall Time | | --- | 50 | 75 | |
| C_{iss} | Input Capacitance | $V_{DS}=-20\text{V}$, $V_{GS}=0\text{V}$, $F=1\text{MHz}$ | --- | 7850 | 11800 | pF |
| C_{oss} | Output Capacitance | | --- | 815 | 1250 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 600 | 900 | |

Guaranteed Avalanche Energy

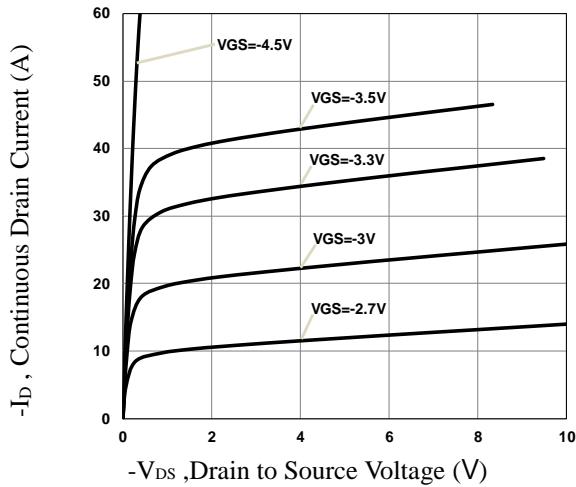
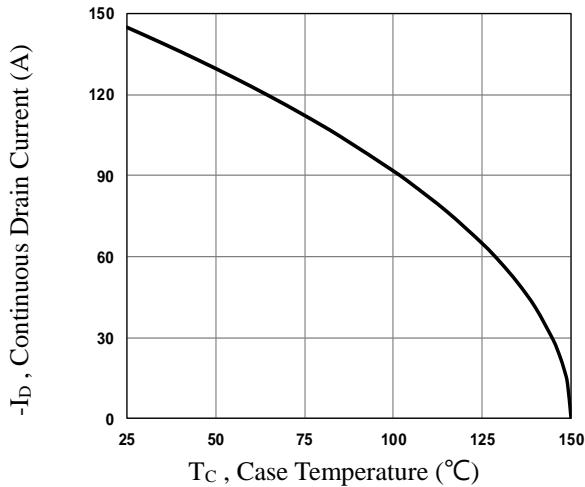
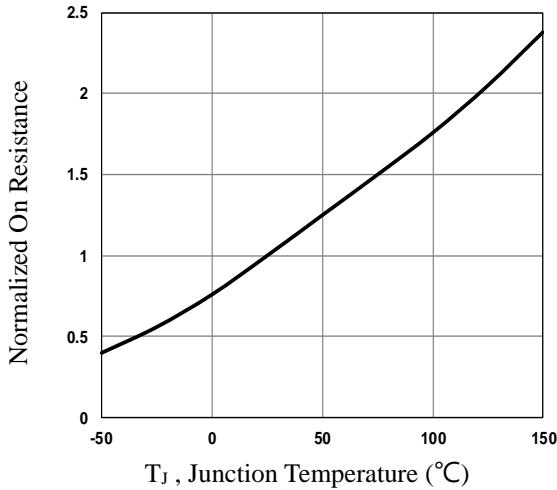
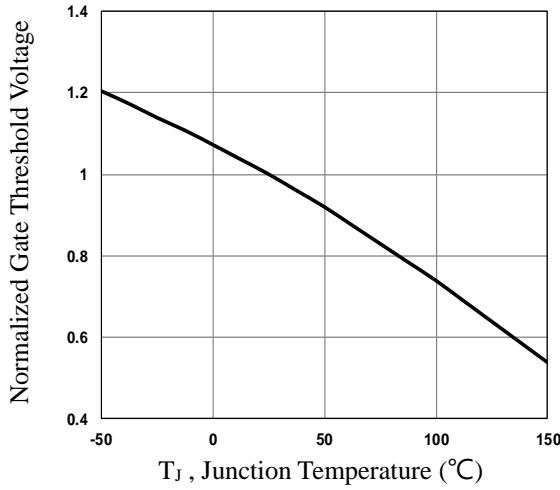
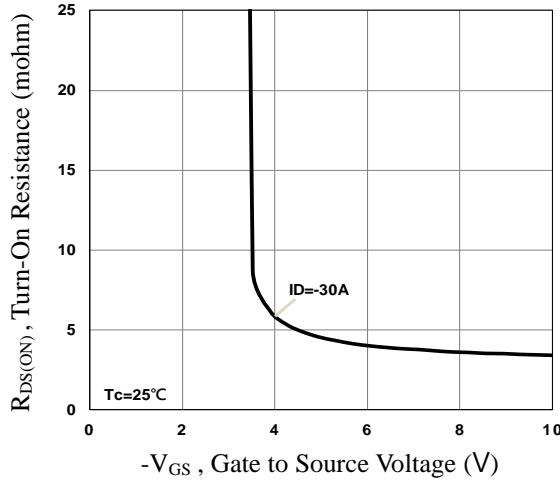
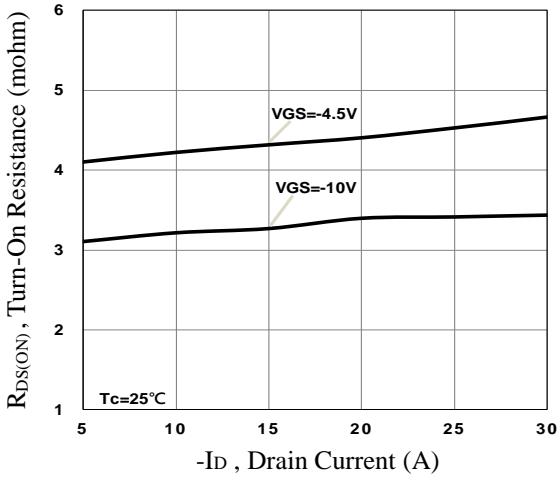
| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-------------------------------|--|------|------|------|------|
| EAS | Single Pulse Avalanche Energy | $V_{DD}=-25\text{V}$, $L=0.1\text{mH}$, $I_{AS}=-47\text{A}$ | 110 | --- | --- | mJ |

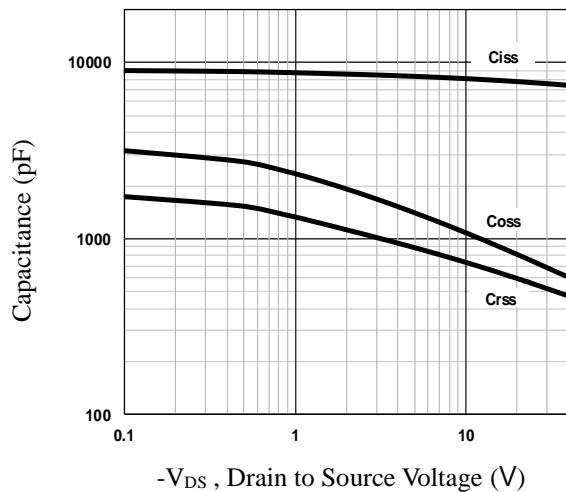
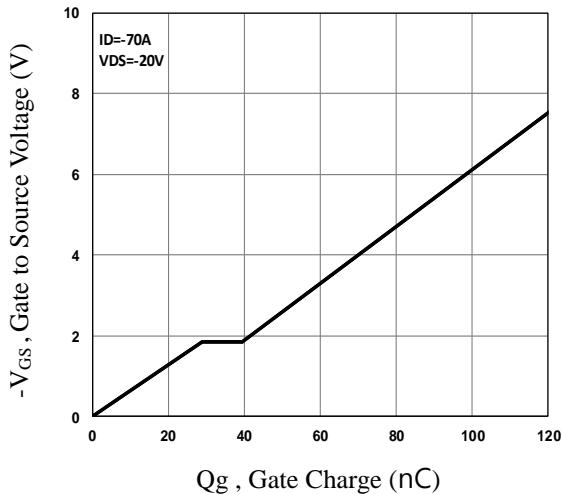
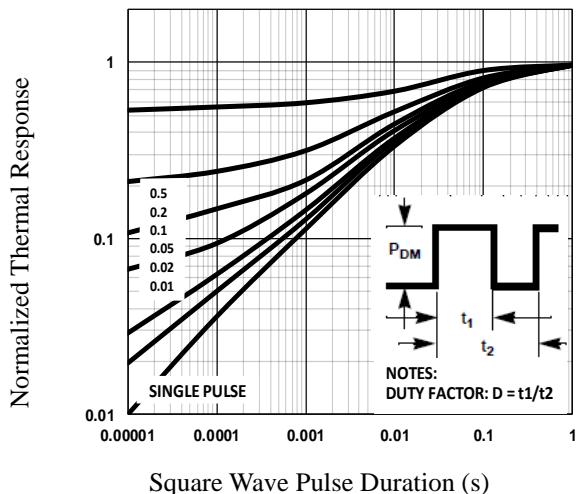
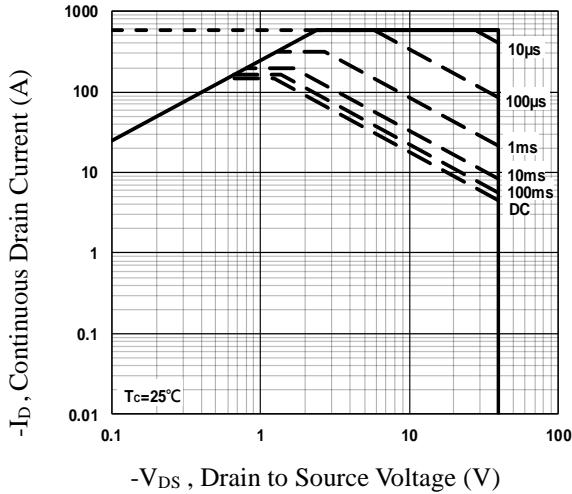
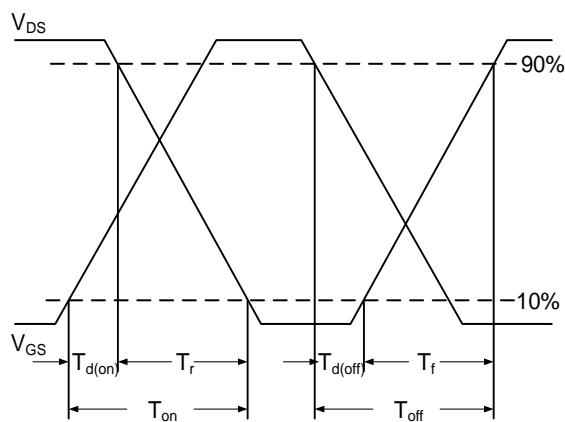
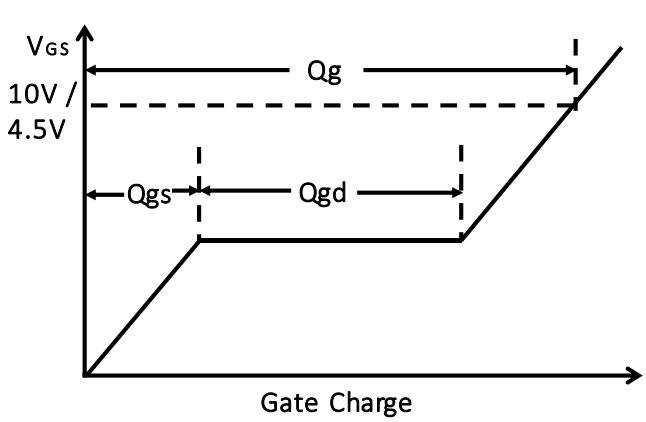
Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|---------------------------|--|------|------|------|------|
| I_s | Continuous Source Current | $V_G=V_D=0\text{V}$, Force Current | --- | --- | -145 | A |
| | | | --- | --- | -290 | A |
| V_{SD} | Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_s=-1\text{A}$, $T_J=25\text{ }^{\circ}\text{C}$ | --- | --- | -1 | V |
| t_{rr} | Reverse Recovery Time | $V_R=-30\text{V}$, $I_s=-10\text{A}$ | --- | 70 | --- | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt=100\text{A}/\mu\text{s}$, $T_J=25\text{ }^{\circ}\text{C}$ | --- | 90 | --- | nC |

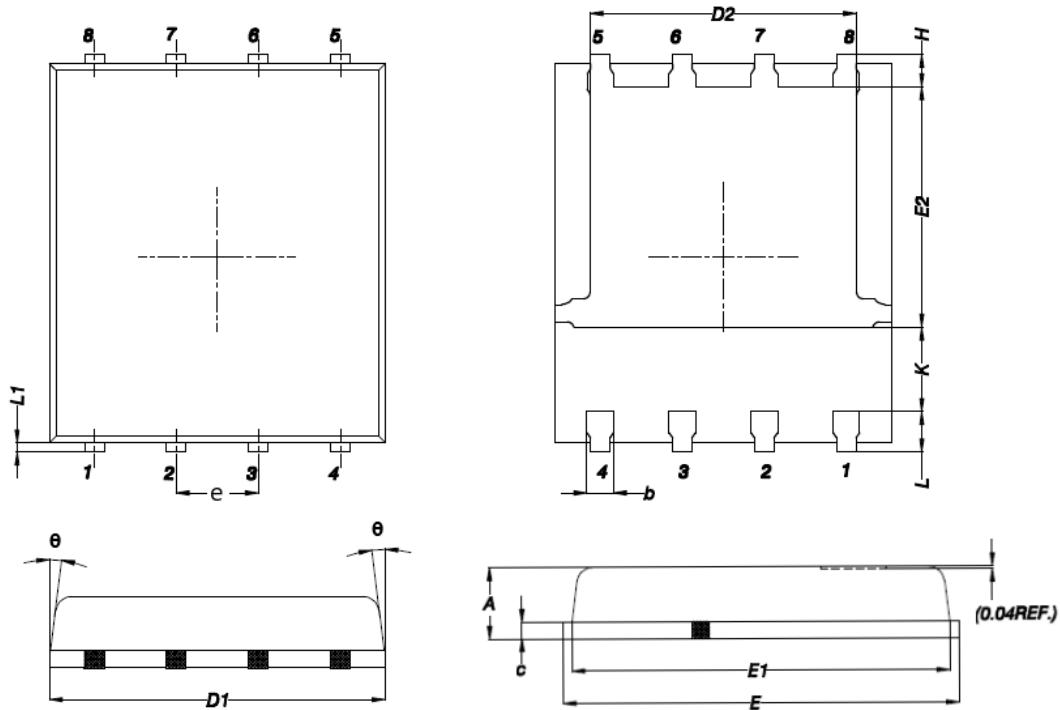
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=-25\text{V}$, $V_{GS}=-10\text{V}$, $L=0.1\text{mH}$, $I_{AS}=-113.5\text{A}$, $R_G=25\Omega$, Starting $T_J=25\text{ }^{\circ}\text{C}$.
3. Essentially independent of operating temperature.

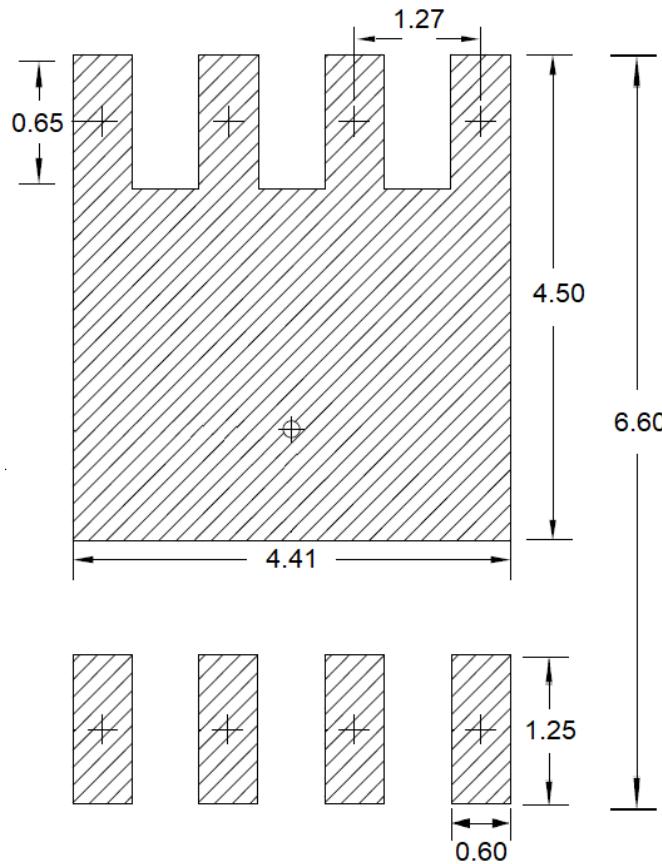

Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized $R_{DS(ON)}$ vs. T_J

Fig.4 Normalized V_{th} vs. T_J

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 Gate Charge Waveform

PPAK5x6 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|----------|---------------------------|-------|----------------------|-------|
| | MAX | MIN | MAX | MIN |
| A | 1.200 | 0.850 | 0.047 | 0.031 |
| b | 0.510 | 0.300 | 0.020 | 0.012 |
| C | 0.300 | 0.200 | 0.012 | 0.008 |
| D1 | 5.400 | 4.800 | 0.212 | 0.189 |
| D2 | 4.310 | 3.610 | 0.170 | 0.142 |
| E | 6.300 | 5.850 | 0.248 | 0.230 |
| E1 | 5.960 | 5.450 | 0.235 | 0.215 |
| E2 | 3.920 | 3.300 | 0.154 | 0.130 |
| e | 1.27BSC | | 0.05BSC | |
| H | 0.650 | 0.380 | 0.026 | 0.015 |
| K | --- | 1.100 | --- | 0.043 |
| L | 0.710 | 0.380 | 0.028 | 0.015 |
| L1 | 0.250 | 0.050 | 0.009 | 0.002 |
| θ | 12° | 0° | 12° | 0° |

PPAK5X6 RECOMMENDED LAND PATTERN

unit : mm